UNISONIC TECHNOLOGIES CO., LTD

7N65L **Preliminary** Power MOSFET

7.4A, 650V N-CHANNEL POWER MOSFET

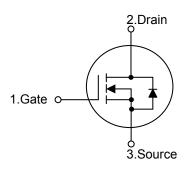
DESCRIPTION

The UTC 7N65L is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in switching power supplies and adaptors.

FEATURES

- * $R_{DS(ON)}$ < 1.2 Ω @ V_{GS} = 10 V
- * Ultra low gate charge (typical 29 nC)
- * Low reverse transfer Capacitance (C_{RSS} = typical 16pF)
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

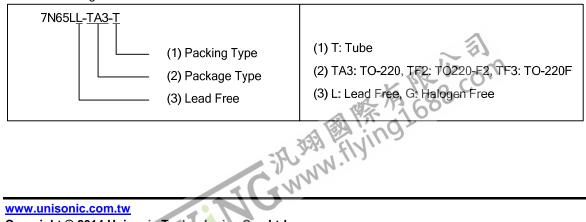
SYMBOL

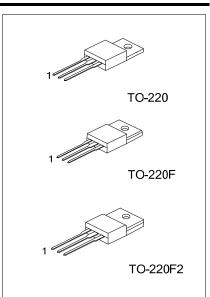


ORDERING INFORMATION

Ordering Number		Dookago	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
7N65LL-TA3-T	7N65LG-TA3-T	TO-220	G	D	S	Tube	
7N65LL-TF2-T	7N65LG-TF2-T	TO-220F2	G	D	S	Tube	
7N65LL-TF3-T	7N65LG-TF3-T	TO-220F	G	D	S	Tube	

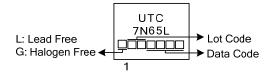
Note: Pin Assignment: G: Gate D: Drain S: Source





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MARKING





ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	650	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Avalanche Current (Note 2)		I_{AR}	7.4	Α	
Drain Current	Continuous	I_{D}	7.4	Α	
	Pulsed (Note 2)	ulsed (Note 2) I _{DM}		Α	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	530	mJ	
	Repetitive (Note 2)	E _{AR}	14.2	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns	
Power Dissipation	TO-220		142		
	TO-220F	P_{D}	48	W	
	TO-220F2		50		
Junction Temperature		TJ	+150	°C	
Storage Temperature		T _{STG}	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 19.5mH, I_{AS} = 7.4A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 7.4A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT	
Junction to Ambient		θ_{JA}	62.5	°C/W	
Junction to Case	TO-220		0.88	°C/W	
	TO-220F	θ_{JC}	2.6		
	TO-220F2		2.5		



ELECTRICAL CHARACTERISTICS (T_C =25°C, unless otherwise specified)

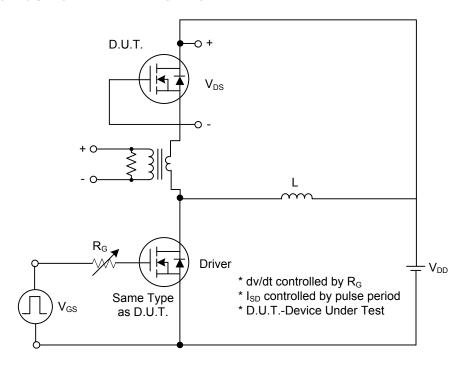
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	650			V
Drain-Source Leakage Current		I_{DSS}	$V_{DS} = 650V, V_{GS} = 0V$			1	μΑ
Gate- Source Leakage Current	Forward	1000	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
	Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
reakdown Voltage Temperature Coefficient		$\triangle BV_{DSS}/\triangle T_{J}$	I _D =250μA,Referenced to 25°C		0.67		V/°C
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} = 10V, I _D = 3.7A		0.94	1.2	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance	nput Capacitance					1400	pF
Output Capacitance	Output Capacitance		V _{DS} =25V, V _{GS} =0V, f=1.0 MHz			180	pF
Reverse Transfer Capacitance		C _{OSS} C _{RSS}	1 = 1.0 MH2		16	21	pF
SWITCHING CHARACTERISTIC	S						
Turn-On Delay Time		t _{D(ON)}				70	ns
Turn-On Rise Time		t _R	V _{DD} =325V, I _D =7.4A,			170	ns
Turn-Off Delay Time		t _{D(OFF)}	R _G =25Ω (Note 1, 2)			140	ns
Turn-Off Fall Time		t _F]			130	ns
SWITCHING CHARACTERISTIC	S						
Total Gate Charge		Q_{G}	V 500V L 7.4A		29	38	nC
Gate-Source Charge		Q_{GS}	V _{DS} =520V, I _D =7.4A,		7		nC
Gate-Drain Charge		Q_{GD}	V _{GS} =10 V (Note1, 2)		14.5		nC
DRAIN-SOURCE DIODE CHARA	CTERISTIC		MUM RATINGS				
Drain-Source Diode Forward Voltage		V_{SD}	$V_{GS} = 0V, I_S = 7.4 A$			1.4	V
Maximum Continuous Drain-Source Diode		Is				7.4	_
Forward Current						7.4	Α
Maximum Pulsed Drain-Source Diode		I _{SM}				29.6	Α
Forward Current						29.0	А
Reverse Recovery Time		t _{rr}	V _{GS} = 0V, I _S = 7.4 A,		320		ns
Reverse Recovery Charge		Q_{RR}	dI _F / dt = 100A/μs (Note 1)		2.4		μC

Notes: 1. Pulse Test: Pulse width≤300µs, Duty cycle≤2%

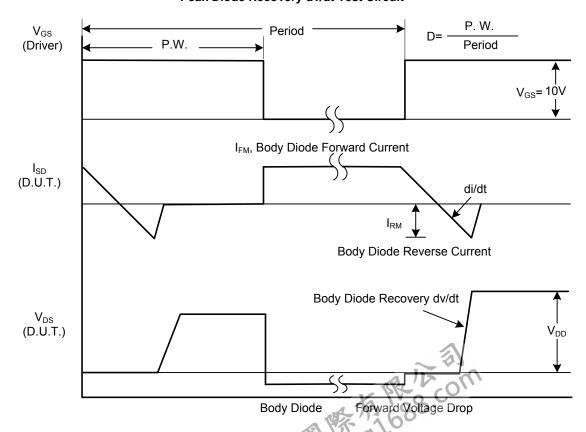
2. Essentially independent of operating temperature



■ TEST CIRCUITS AND WAVEFORMS

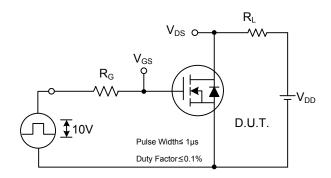


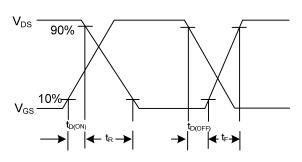
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dwdt Waveforms

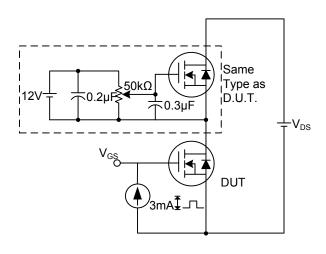
TEST CIRCUITS AND WAVEFORMS (Cont.)

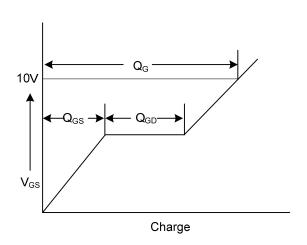




Switching Test Circuit

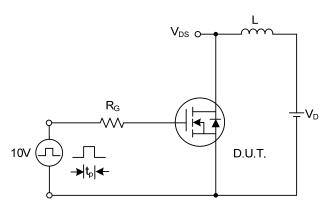
Switching Waveforms

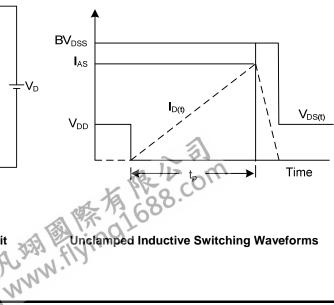




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

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